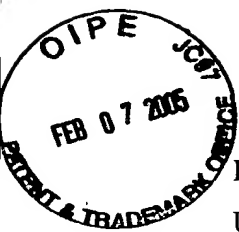


2/14/05
JFE



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re

U.S. Application of:

Kenichi MORITA, Keisuke HASHIMOTO, and
Kenichi YAKAHASHI

For:

MULTI-LINE COMMUNICATION
APPARATUS AND METHOD OF USE

Confirmation No.:

9594

U.S. Serial No.:

09/631,414

Filed:

August 3, 2000

Group Art Unit:

2141

Examiner:

Paul H. Kang

MAIL STOP AMENDMENT

Commissioner for Patents

P. O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: MAIL STOP AMENDMENT, Commissioner for Patents, P. O. Box 1450, Alexandria, VA 22313-1450, on

February 2, 2005

Date of Deposit

TUNG T. NGUYEN

Name of Applicant, Assignee, or Registered
Representative

Signature

February 2, 2005

Date of Signature

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT
UNDER 37 C.F.R. §1.97(e)

In compliance with the duty of disclosure set forth in 37 C.F.R. § 1.56 and § 1.97(e), Applicants wish to bring the following items to the attention of the Examiner. A copy of each document is enclosed for the convenience of the Examiner.

No representation is made, and no representation is intended, that more relevant material does not exist, or that the order of presentation of this material in any way reflects its relative pertinence.

Specifically, this presentation is not an admission that the items listed below are properly citable against the above-identified application.

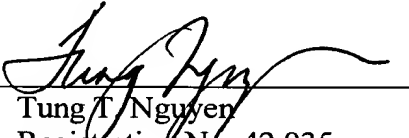
Submitted herewith is a copy of a Japanese Notice on Reason for Rejection, dated December 21, 2004, for counterpart Japanese Patent Application No. 11-223622, along with an English translation thereof. The Japanese Notice cites the following references in the order listed below:

- (1) Japanese Patent Laid-Open Publication No. (A) 10-145574,
(MATSUSHITA ELECTRIC IND CO LTD), published May 29, 1998;
and
- (2) Japanese Patent Laid-Open Publication No. (A) 10-155038, (CASIO
COMPUT CO LTD), published June 9, 1998.

In accordance with 37 CFR § 1.97(e), it is hereby certified that each item of information contained in this Supplemental Information Disclosure Statement is being filed within three months of being first cited in a foreign communication in a counterpart foreign application, no fee is incurred. If it should be determined that a fee is required, please charge any required fee (other than the issue fee) during the pendency of this application to Sidley Austin Brown & Wood LLP's Deposit Account No. 18-1260.

Respectfully submitted,

By: _____


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Substitute for form 1449A/PTO SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANTS				Complete if Known Application Number 09/631,414 Confirmation No. 9594 Filing Date August 3, 2000 First Inventor Kenichi MORITA et al. Group Art Unit 2141 Examiner Name Paul H. Kang Attorney Docket No. 15162/02390				
Sheet	1	of	1					
U.S. PATENT DOCUMENTS								
Examiner Initials	Cite #	DOCUMENT NUMBER	C O D E	PATENTEE	ISSUE DATE (mm/dd/yy)	CLASS	SUB CLASS	Filing Date if Appropriate
FOREIGN PATENT DOCUMENTS								
Examiner Initials		O F F I C E	NUMBER	C O D E	PUBLICATION DATE (mm/dd/yy)	TRANSLATION Yes No		
	(1)	JP	10-145574	A	05/29/1998	X		
	(2)	JP	10-155038	A	06/09/1998	X		
OTHER NON PATENT LITERATURE DOCUMENTS								
Examiner Initials	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published							
Examiner Signature					Date Considered			

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with the next communication to applicant.